SMT inductors

SIMID series, SIMID 0805-F

Series/Type: **B82498F**

Date: March 2008

SMD

Size 0805 (EIA) and/or 2012 (IEC)
Rated inductance 2.7 nH to 6800 nH
Rated current 80 mA to 1000 mA

Construction

- Cubic coil with ceramic or ferrite core
- Epoxy-molded flat top for vacuum pickup
- Winding ends welded to terminals

Features

- High resonance frequency
- Close inductance tolerance
- Suitable for lead-free reflow soldering
- RoHS-compatible

Applications

Resonant circuits, impedance matching for

- Antenna amplifiers
- Multimedia
- Wireless communication systems
- Car access systems
- TPMS (Tire Pressure Monitoring System)
- GPS (Global Positioning System)

Terminals

- Standard version:
  - Base material Al_2O_3 ceramic and ferrite
  - Thick-film coating of Ag/Pd/Pt
- Gold-plated terminals:
  - Base material Al_2O_3 ceramic
  - Layer composition W/Ni/Au
  - Electro-plated

Marking

- No marking on component
- Minimum data on reel:
  Manufacturer, ordering code, L value, quantity, date of packing

Delivery mode and packing unit

- 8-mm blister tape, wound on 180-mm reel
- Packing unit: 3000 pcs./reel

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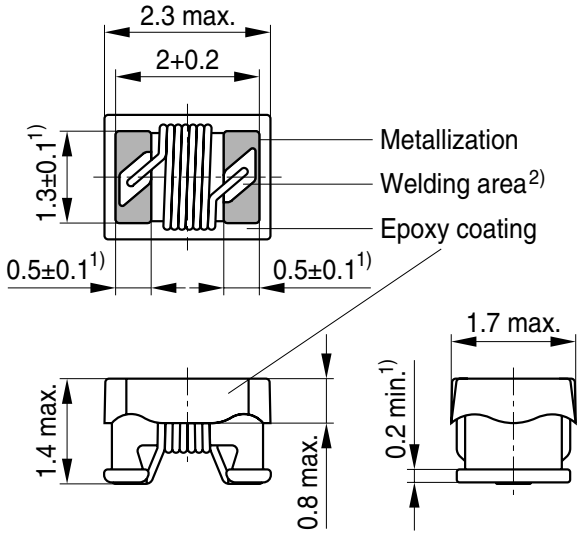
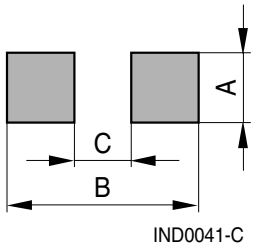
Dimensional drawing and layout recommendation





IND0041-C

A	B	C
1.5 ±0.2	3.2 ±0.4	1.0 ±0.1

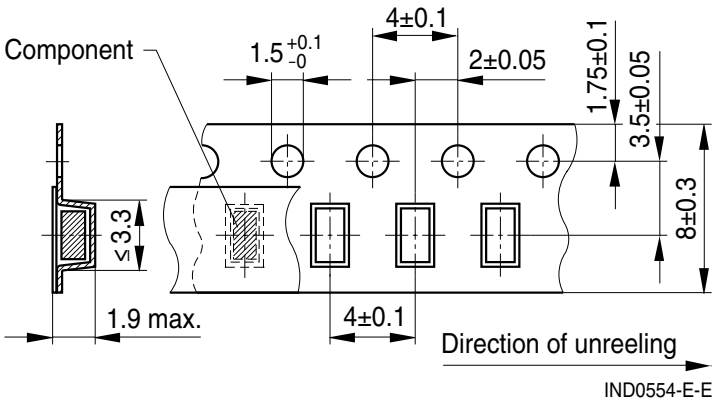
1) Soldering area
2) This area (30% of contact area) should not be used to assess solderability

IND0542-S-E

Dimensions in mm

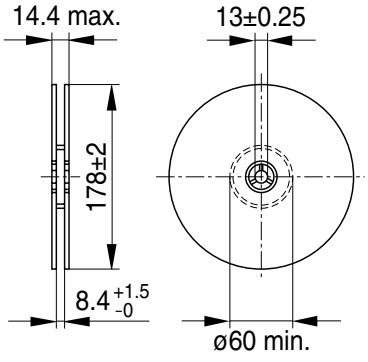
Taping and packing

Blister tape



IND0554-E-E

Reel



IND0581-C

Dimensions in mm

Technical data and measuring conditions

Rated inductance L_R	Measured with impedance analyzer Agilent 4291A and test fixture Agilent 16197A at frequency f_L, 0.1 V, 20 °C. Pad distance 0.9 ±0.1 (mm) Short inductance 200 pH unconsidered
Q factor Q_{min}	Measured with impedance analyzer Agilent 4291A and test fixture Agilent 16197A at frequency f_Q, 20 °C. Pad distance 0.9 ±0.1 (mm) Short inductance 200 pH unconsidered
Rated temperature T_R	105 °C
Rated current I_R	Maximum permissible DC with inductance decrease $\Delta L/L_0 \leq 10\%$ and temperature increase of ≤ 20 K at rated temperature
Self-resonance frequency $f_{res,min}$	Measured with network analyzer Agilent 8720D, 20 °C
DC resistance R_{max}	Measured at 20 °C
Solderability (lead-free)	Sn95.5Ag3.8Cu0.7: (245 ±5) °C, (5 ±0.3) s Wetting of soldering area ≥ 90% (based on IEC 60068-2-58)
Resistance to soldering heat	Standard version: 260 °C, 20 s (as referenced in JEDEC J-STD 020C) Gold-plated terminals: 260 °C, 40 s (as referenced in JEDEC J-STD 020C)
Climatic category	55/125/56 (to IEC 60068-1)
Storage conditions	Mounted: –55 °C … +125 °C Packaged: –25 °C … +40 °C, ≤ 75% RH
Weight	Approx. 10 mg

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Characteristics and ordering codes

L_R nH	Tolerance	f_L MHz	Q_{min}	f_Q MHz	I_R mA	R_{max} Ω	$f_{res,min}$ MHz	Ordering code[1)2)] (standard version)
Core material: ceramic								
2.7	±10% ≙ K	250	50	1500	1000	0.03	9000	B82498F3279K000
5.6		250	50	1000	900	0.04	7000	B82498F3569K000
6.8		250	50	1000	800	0.05	6000	B82498F3689K000
8.2		250	50	1000	700	0.09	5000	B82498F3829K000
10	±2% ≙ G	250	50	500	700	0.09	5000	B82498F3100+000
12	±5% ≙ J	250	50	500	700	0.09	4000	B82498F3120+000
15		250	50	500	650	0.13	3300	B82498F3150+000
18		250	60	500	700	0.08	3300	B82498F3180+000
22		250	60	500	700	0.08	2500	B82498F3220+000
27		250	60	500	700	0.09	2500	B82498F3270+000
33		250	65	500	600	0.11	2200	B82498F3330+000
39		250	65	500	600	0.12	2100	B82498F3390+000
47		200	65	500	600	0.13	2000	B82498F3470+000
56		200	60	500	600	0.14	1700	B82498F3560+000
68		200	60	500	500	0.18	1600	B82498F3680+000
82		150	60	500	500	0.19	1500	B82498F3820+000
100		150	55	500	450	0.28	1350	B82498F3101+000
120		150	50	250	440	0.31	1250	B82498F3121+000
150		100	45	250	400	0.42	1150	B82498F3151+000
180		100	45	250	340	0.53	1050	B82498F3181+000
220		100	45	250	320	0.70	950	B82498F3221+000
270		100	45	250	270	1.0	900	B82498F3271+000
330		100	45	250	220	1.5	800	B82498F3331+000
390		100	40	250	210	1.6	700	B82498F3391+000
470		50	30	100	190	1.9	650	B82498F3471+000
560		25	23	50	230	1.3	400	B82498F3561+000
680		25	23	50	190	1.7	300	B82498F3681+000
820		25	23	50	180	1.9	300	B82498F3821+000

Higher currents possible at temperatures $<T_R$ on request.

Sample kit for standard version available. Ordering code: B82498X001
For more information refer to chapter “Sample kits”.

1) For gold-plated terminals the last digit has to be a “1”. Example: B82498F3279K001
2) Replace the + by the code letter for the required inductance tolerance.

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Characteristics and ordering codes

L_R nH	Tolerance	f_L MHz	Q_{min}	f_Q MHz	I_R mA	R_{max} Ω	$f_{res,min}$ MHz	Ordering code[1] (standard version)
Core material: ferrite								
1000	±5% ≙ J	7.96	20	7.96	240	0.55	440	B82498F1102J000
1200		7.96	20	7.96	220	0.65	420	B82498F1122J000
1500		7.96	20	7.96	200	0.70	380	B82498F1152J000
1800		7.96	20	7.96	190	0.98	350	B82498F1182J000
2200		7.96	20	7.96	130	1.60	330	B82498F1222J000
2700		7.96	20	7.96	120	2.0	270	B82498F1272J000
3300		7.96	20	7.96	100	3.3	250	B82498F1332J000
3900		7.96	20	7.96	95	3.6	230	B82498F1392J000
4700		7.96	20	7.96	90	3.8	210	B82498F1472J000
5600		7.96	20	7.96	85	4.3	180	B82498F1562J000
6800		7.96	20	7.96	80	4.7	140	B82498F1682J000

Higher currents possible at temperatures $<T_R$ on request.

Sample kit of standard version available. Ordering code: B82498X001
For more information refer to chapter “Sample kits”.

1) Replace the + by the code letter for the required inductance tolerance.

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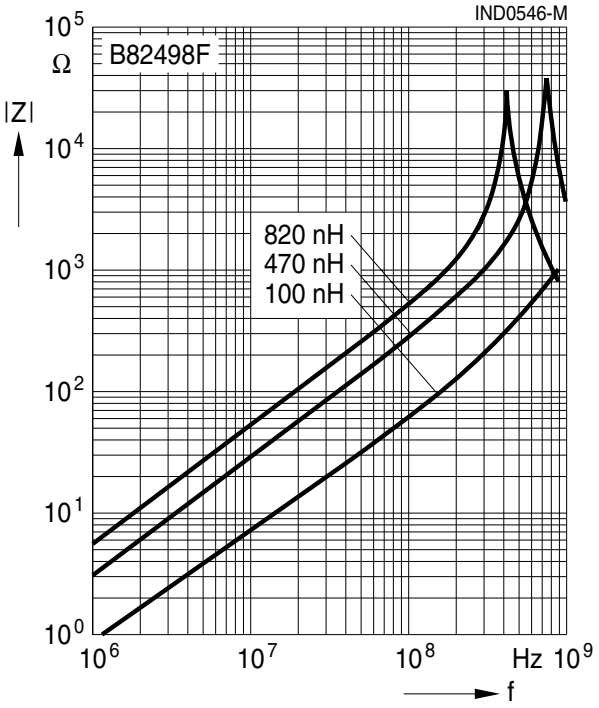
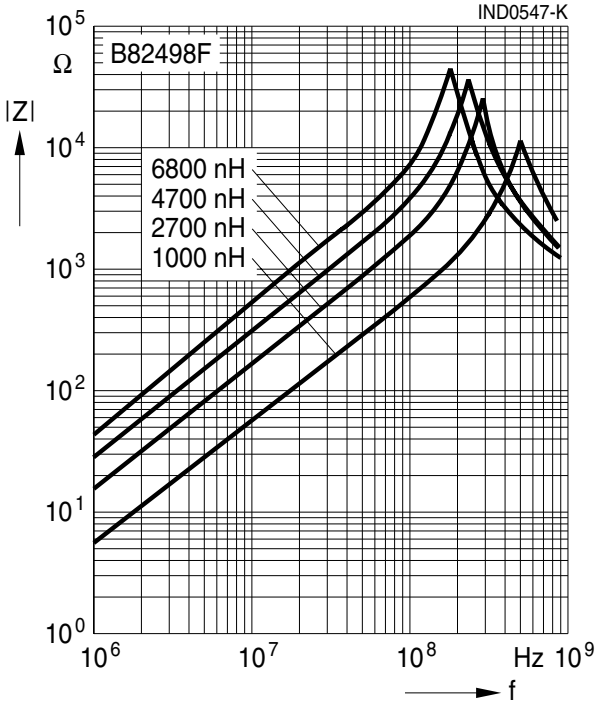
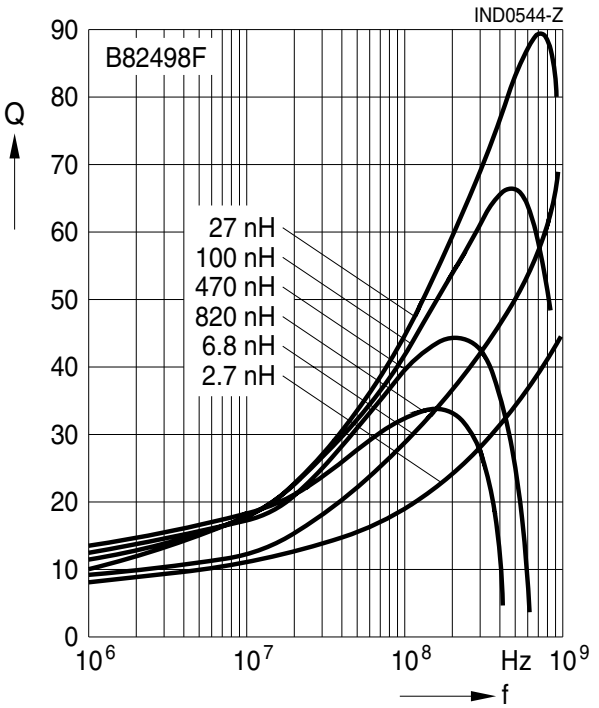
Impedance |Z| vs. frequency f (ceramic core)
measured with impedance analyzer
Agilent 4291A, typical values at 20 °C



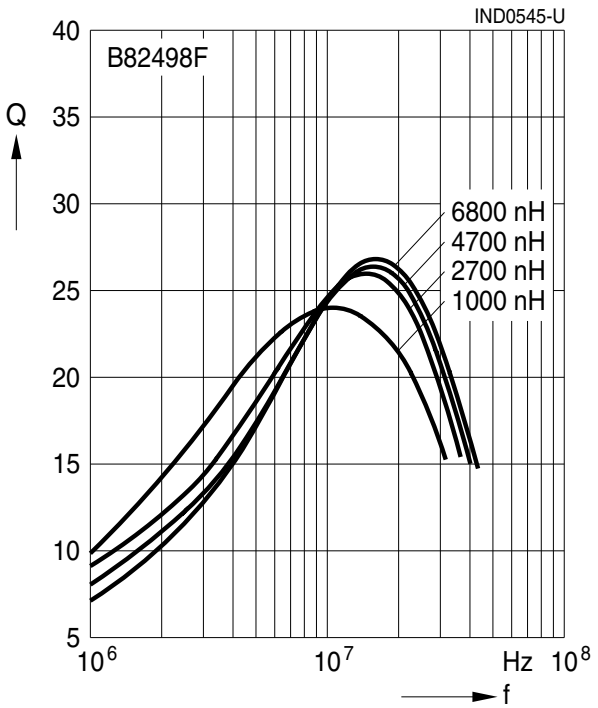
Impedance |Z| vs. frequency f (ferrite core)
measured with impedance analyzer
Agilent 4291A, typical values at 20 °C



Q factor versus frequency f (ceramic core)
measured with impedance analyzer
Agilent 4291A, typical values at 20 °C



Q factor versus frequency f (ferrite core)
measured with impedance analyzer
Agilent 4291A, typical values at 20 °C



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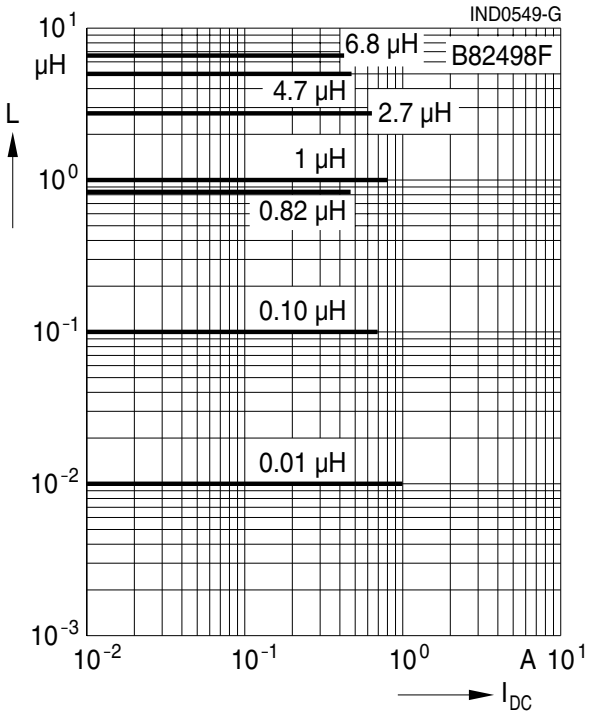
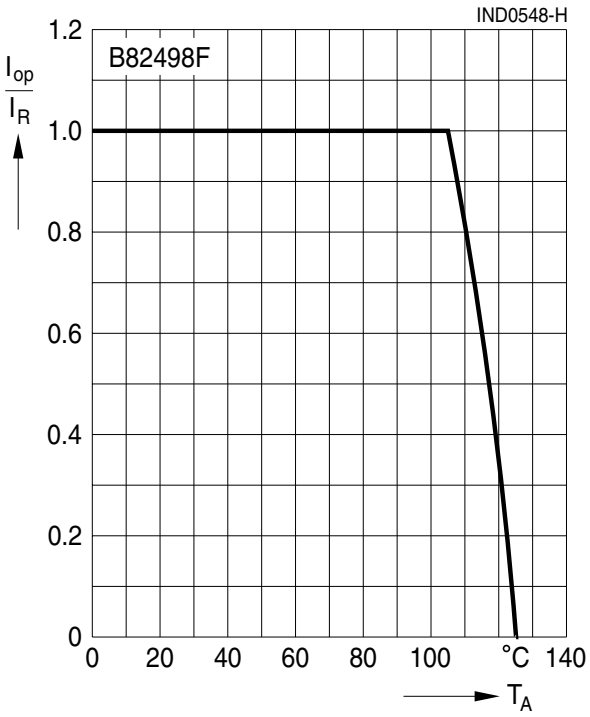
Inductance L versus DC load current I_{DC}
measured with RF LCR meter
Agilent 4275A, typical values at 20 °C



Current derating I_{op}/I_R
versus ambient temperature T_A
(rated temperature T_R = 105 °C)



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.**

   As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.

2. We also point out that **in individual cases, a malfunction of passive electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified.** In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of a passive electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of a passive electronic component.

3. **The warnings, cautions and product-specific notes must be observed**.

4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.

5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.

   We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available.

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- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
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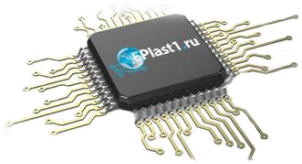
- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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